August 1995

54F/74F379 Quad Parallel Register with Enable

General Description

The 'F379 is a 4-bit register with buffered common Enable. This device is similar to the 'F175 but features the common Enable rather than common Master Reset.

Features

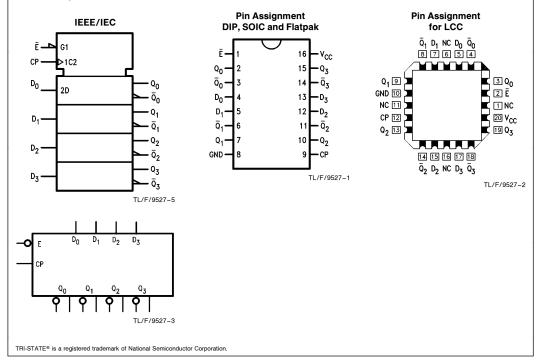
- Edge triggered D-type inputs
- Buffered positive edge-triggered clock
- Buffered common enable input
- True and complement outputs
- Guaranteed 4000V minimum ESD protection

Commercial	Military	Package Number	Package Description			
74F379PC		N16E	16-Lead (0.300" Wide) Molded Dual-In-Line			
	54F379DM (QB)	J16A	16-Lead Ceramic Dual-In-Line			
74F379SC (Note 1)		M16A	16-Lead (0.300" Wide) Molded Small Outline, JEDEC			
74F379SJ (Note 1)		M16D	16-Lead (0.300" Wide) Molded Small Outline, EIAJ			
	54F379FM (QB)	W16A	16-Lead Cerpack			
	54F379LM (QB)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C			

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Logic Symbols

Connection Diagrams



Unit Loading/Fan Out

		54F/74F			
Pin Names	Description	U.L. HIGH/LOW	Input I _{IH} /I _{IL} Output I _{OH} /I _{OL}		
Ē	Enable Input (Active LOW)	1.0/1.0	20 μA/ -0.6 mA		
$D_0 - D_3$	Data Inputs	1.0/1.0	20 μA/ -0.6 mA		
CP	Clock Pulse Input (Active Rising Edge)	1.0/1.0	20 μA/ -0.6 mA		
Q ₀ -Q ₃	Flip-Flop Outputs	50/33.3	-1 mA/20 mA		
$\overline{Q}_0 - \overline{Q}_3$	Complement Outputs	50/33.3	-1 mA/20 mA		

Functional Description

The 'F379 consists of four edge-triggered D-Type flip-flops with individual D inputs and Q and $\overline{\rm Q}$ outputs. The Clock (CP) and Enable (E) inputs are common to all flip-flops. When the \overline{E} is input HIGH, the register will retain the present data independent of the CP input. The D_n and \overline{E} inputs can change when the clock is in either state, provided that the recommended setup and hold times are observed.

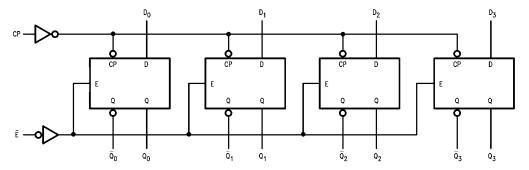
Truth Table

	Inputs	Outputs			
Ē	СР	Qn	$\overline{\mathbf{Q}}_{\mathbf{n}}$		
Н	_	Х	NC	NC	
L	\mathcal{L}	Н	Н	L	
L		L	L	Н	

H = HIGH Voltage Level

H = High Voltage Level
L = LOW Voltage Level
X = Immaterial
✓ = LOW-to-HIGH Transition
NC = No Change

Logic Diagram



TL/F/9527-4

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to } +175^{\circ}\mbox{C} \\ \mbox{Plastic} & -55^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \end{array}$

V_{CC} Pin Potential to

Voltage Applied to Output

in HIGH State (with $V_{CC} = 0V$)

 $\begin{array}{lll} \mbox{Standard Output} & -0.5\mbox{V to V}_{CC} \\ \mbox{TRI-STATE} \mbox{$^{\circ}$ Output} & -0.5\mbox{V to } +5.5\mbox{V} \end{array}$

Current Applied to Output in LOW State (Max) twice the rated I_{OL} (mA) ESD Last Passing Voltge (Min) 4000V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature

Supply Voltage

Military + 4.5V to + 5.5V Commercial + 4.5V to + 5.5V

DC Electrical Characteristics

Symbol	Parameter		54F/74F			Units	v _{cc}	Conditions	
Symbol			Min	Тур	Max	Onits	VCC	Conditions	
V_{IH}	Input HIGH Voltage			2.0			٧		Recognized as a HIGH Signal
V_{IL}	Input LOW Voltage					0.8	٧		Recognized as a LOW Signal
V_{CD}	Input Clamp Diode Vo	oltage				-1.2	V	Min	$I_{IN} = -18 \text{ mA}$
V _{OH}	Output HIGH Voltage	74F	10% V _{CC} 10% V _{CC} 5% V _{CC}	2.5 2.5 2.7			V	Min	$I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$
V _{OL}	Output LOW Voltage		10% V _{CC} 10% V _{CC}			0.5 0.5	٧	Min	$I_{OL} = 20 \text{ mA}$ $I_{OL} = 20 \text{ mA}$
I _{IH}	Input HIGH Current	54F 74F				20.0 5.0	μΑ	Max	$V_{IN} = 2.7V$
I _{BVI}	Input HIGH Current Breakdown Test	54F 74F				100 7.0	μΑ	Max	V _{IN} = 7.0V
I _{CEX}	Output HIGH Leakage Current	54F 74F				250 50	μΑ	Max	V _{OUT} = V _{CC}
V_{ID}	Input Leakage Test	74F		4.75			V	0.0	$I_{\text{ID}} = 1.9 \mu\text{A}$ All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current	74F				3.75	μΑ	0.0	V _{IOD} = 150 mV All Other Pins Grounded
I _{IL}	Input LOW Current				-0.6	mA	Max	V _{IN} = 0.5V	
Ios	Output Short-Circuit Current		-60		-150	mA	Max	V _{OUT} = 0V	
I _{CCL}	Power Supply Curren	t			28	40	mA	Max	$V_O = LOW$

AC Electrical Characteristics

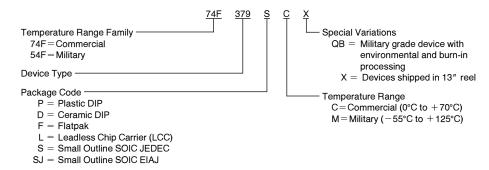
					54F T _A , V _{CC} = Mil C _L = 50 pF		74F T _A , V _{CC} = Com C _L = 50 pF		Units
Symbol	Parameter								
		Min	Тур	Max	Min	Max	Min	Max	
f _{max}	Maximum Clock Frequency	100	140		75		100		MHz
t _{PLH}	Propagation Delay CP to Q_n , \overline{Q}_n	3.5 5.0	5.0 6.5	6.5 8.5	3.0 4.0	8.5 10.0	3.5 5.0	7.5 9.5	ns

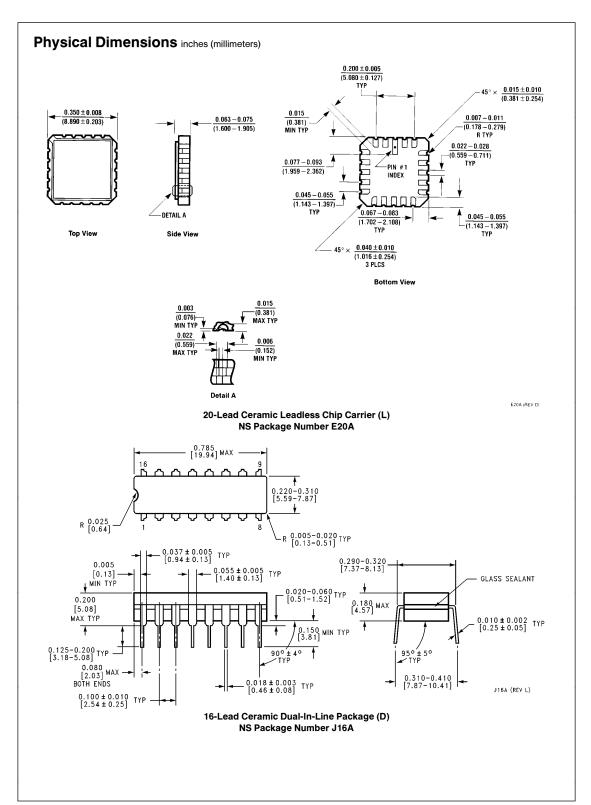
AC Operating Requirements

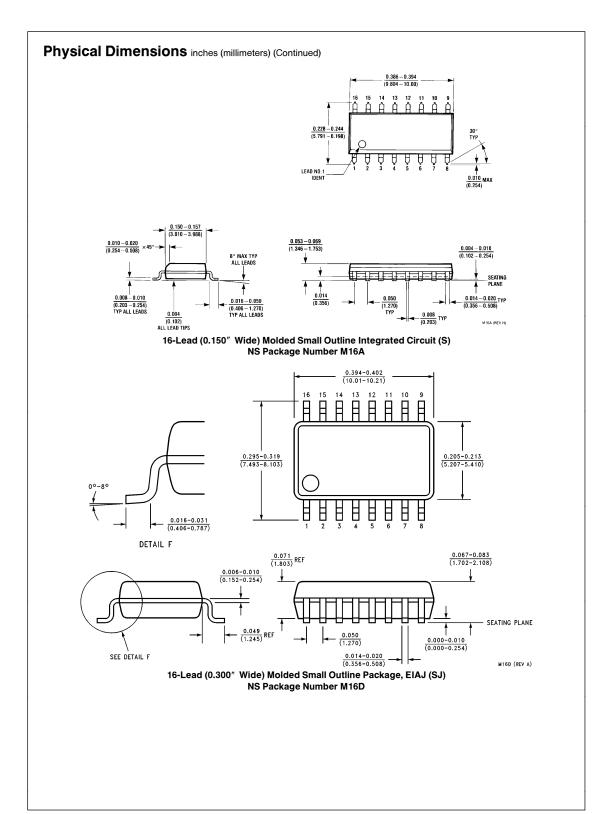
		$74F$ $T_{A} = +25^{\circ}C$ $V_{CC} = +5.0V$		54	F	74F T _A , V _{CC} = Com		Units
Symbol	Parameter			TA, VCC	; = Mil			
		Min	Max	Min	Max	Min	Max	
t _s (H) t _s (L)	Setup Time, HIGH or LOW D _n to CP	3.0 3.0		4.0 4.0			3.0 3.0	ns
t _h (H)	Hold Time, HIGH or LOW D _n to CP	1.0 1.0		2.0 2.0			1.0 1.0	113
t _s (H)	Setup Time, HIGH or LOW E to CP	6.0 6.0		8.0 8.0			6.0 6.0	ns
t _h (H)	Hold Time, HIGH or LOW E to CP	0 0		0			0 0	113
t _w (H) t _w (L)	CP Pulse Width HIGH or LOW	4.0 5.0		5.0 7.0			4.0 5.0	ns

Ordering Information

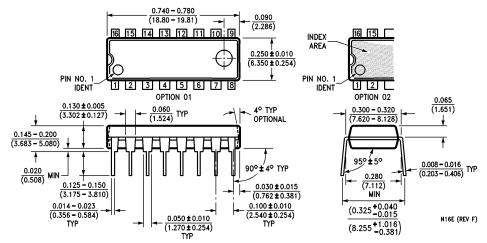
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:





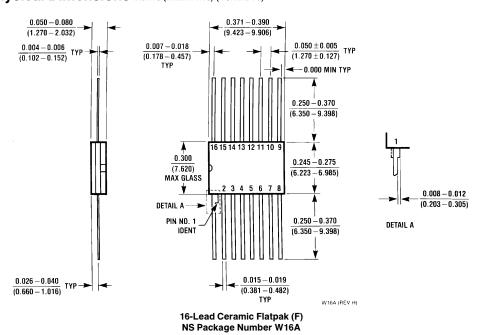






16-Lead (0.300" Wide) Molded Dual-In-Line Package (P)
NS Package Number N16E

Physical Dimensions inches (millimeters) (Continued)



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